SEMICONDUCTOR

## DESCRIPTION

The SD24C is designed for applications requiring transient overvoltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. These devices are ideal for situations where board space is at a premium.

This series has been specifically designed to protect sensitive components which are connected to power, data and transmission lines from overvoltage caused by ESD(electrostatic discharge), CDE (Cable Discharge Events),and EFT (electrical fast transients).

ORDERING INFORMATION
४Package: SOD-323
$\diamond$ Material: Halogen free
«Packing: Tape \& Reel
$\diamond$ Quantity per reel: 3,000pcs

## FEATURES

$\diamond$ IEC61000-4-2 (ESD) $\pm 15 \mathrm{kV}$ (air), $\pm 8 \mathrm{kV}$ (contact)
১IEC61000-4-4 (EFT) 40A (5/50ns)
$\diamond 350$ Watts Peak Pulse Power per ( $\mathrm{tp}=8 / 20 \mu \mathrm{~s}$ )
$\diamond$ Protects one I/O line (bidirectional)
২Low clamping voltage
$\diamond$ Low leakage current

## MACHANICAL DATA

$\diamond$ SOD-323 package
\&Flammability Rating: UL 94V-0
$\diamond$ Packaging: Tape and Reel
$\diamond$ High temperature soldering guaranted: $260{ }^{\circ} \mathrm{C} / 10 \mathrm{~s}$ $\diamond$ Reel size: 7 inch

## APPLICATIONS

$\diamond$ Cell Phone Handsets and Accessories
$\diamond$ Microprocessor based equipment
$\diamond$ Personal Digital Assistants (PDA's)
$\diamond$ Notebooks, Desktops, and Servers
«Portable Instrumentation
$\diamond$ Networking and Telecom
$\diamond$ Serial and Parallel Ports.
$\checkmark$ Peripherals

## PACKAGE OUTLINE



SEMICONDUCTOR

ABSOLUTE MAXIMUM RATING

| Symbol | Parameter | Value | Units |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\text {ESD }}$ | ESD per IEC 61000-4-2 (Air) <br> ESD per IEC 61000-4-2 (Contact) | $\pm 15$ <br> $\pm 8$ | kV |
| $\mathrm{P}_{\mathrm{PP}}$ | Peak Pulse Power (8/20 $\mu \mathrm{s})$ | 350 | W |
| $\mathrm{~T}_{\text {OPT }}$ | Operating Temperature | $-55 /+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature | $-55 /+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Lead Soldering Temperature | $260(10 \mathrm{sec})$. | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS (Tamb=25 ${ }^{\circ} \mathrm{C}$ )

| PART <br> NUMBER | DEVICE <br> MARKING | $\begin{gathered} \mathrm{V}_{\mathrm{RWM}} \\ (\mathrm{~V}) \\ \text { (max.) } \end{gathered}$ | $\begin{gathered} \hline \mathrm{V}_{\mathrm{B}} \\ (\mathrm{~V}) \\ (\min .) \end{gathered}$ | $\begin{gathered} \mathrm{I}_{\mathrm{T}} \\ (\mathrm{~mA}) \end{gathered}$ | $\mathrm{V}_{\mathrm{c}} @ 1 \mathrm{~A}$ <br> (V) <br> (max.) | $V_{c}$ <br> (V) |  | $\begin{gathered} \mathrm{I}_{\mathrm{R}} \\ (\mu \mathrm{~A}) \\ (\max .) \end{gathered}$ | $\begin{gathered} \mathrm{C}_{\mathrm{T}} \\ (\mathrm{pF}) \\ (\max .) \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SD24C | 2 H | 24.0 | 26.7 | 1 | 43.0 | 52.0 | 7 | 1 | 50 |

## ELECTRICAL CHARACTERISTICS CURVE



Pulse Waveform


Power Derating Curve


Non-Repetitive Peak Pulse Power vs. Pulse Time


Junction Capacitance vs. Reverse Voltage

SOD-323 PACKAGE OUTLINE DIMENSIONS


| Symbol | Dimensions In Millimeters |  |
| :---: | :---: | :---: |
|  | Min | Max |
| A |  | 1.00 |
| A1 | 0.000 | 0.100 |
| A2 | 0.800 | 0.900 |
| b | 0.250 | 0.350 |
| c | 0.080 | 0.150 |
| D | 1.200 | 1.400 |
| E | 1.600 | 1.800 |
| E1 | 2.500 | 2.700 |
| e | 1.800 | 2.040 |
| L | 0.475 REF |  |
| L1 | 0.250 | 0.400 |
| $\theta$ | $0^{\circ}$ | $8^{\circ}$ |



